SPECIFICATION
FOR
LCM Module

MODULE No:	RXL043022-F
CUSTOMER:	

RESHINE	INITIAL	DATE
PREPARED BY		
CHECKED BY		
APPROVED BY		

CUSTOMER	INITIAL	DATE
APPROVED BY		

Revision History

Date	Rev. No.	Page	Summary
2020.03.03	V1.0	ALL	FIRST ISSUE
2021.07.20	V1.1	7	Correct PIN 33/34

Contents

1. Block Diagram 5
2. Outline dimension 6
3. Input terminal Pin Assignment 7
4. LCD Optical Characteristics 9
4.1 Optical specification 9
5. Electrical Characteristics 12
5.1 Absolute Maximum Rating 12
5.2 DC Electrical Characteristics 12
5.3 LED Backlight Characteristics 13
6. AC Characteristics 15
6.1 LVDS Input Data Position 15
6.2 LVDS Data Timing Diagram 16
7. LCD Module Out-Going Quality Level 18
7.1 VISUAL & FUNCTION INSPECTION STANDARD 18
7.1.1 Inspection conditions 18
7.1.2 Definition 18
7.1.3 Sampling Plan 19
7.1.4 Criteria (Visual) 20
8. Reliability Test Result 23
9. Cautions and Handling Precautions 24
9.1 Handling and Operating the Module 24
9.2 Storage and Transportation. 24
10. Packing 25

* Description

This is a color active matrix TFT (Thin Film Transistor) LCD (liquid crystal display) that uses amorphous silicon TFT as a switching device. This model is composed of a Transmissive type TFT-LCD Panel,driver circuit, back-light unit. The resolution of a 4.3'TFT-LCD contains 800x480 pixels, and can displayup to 16.7M colors.

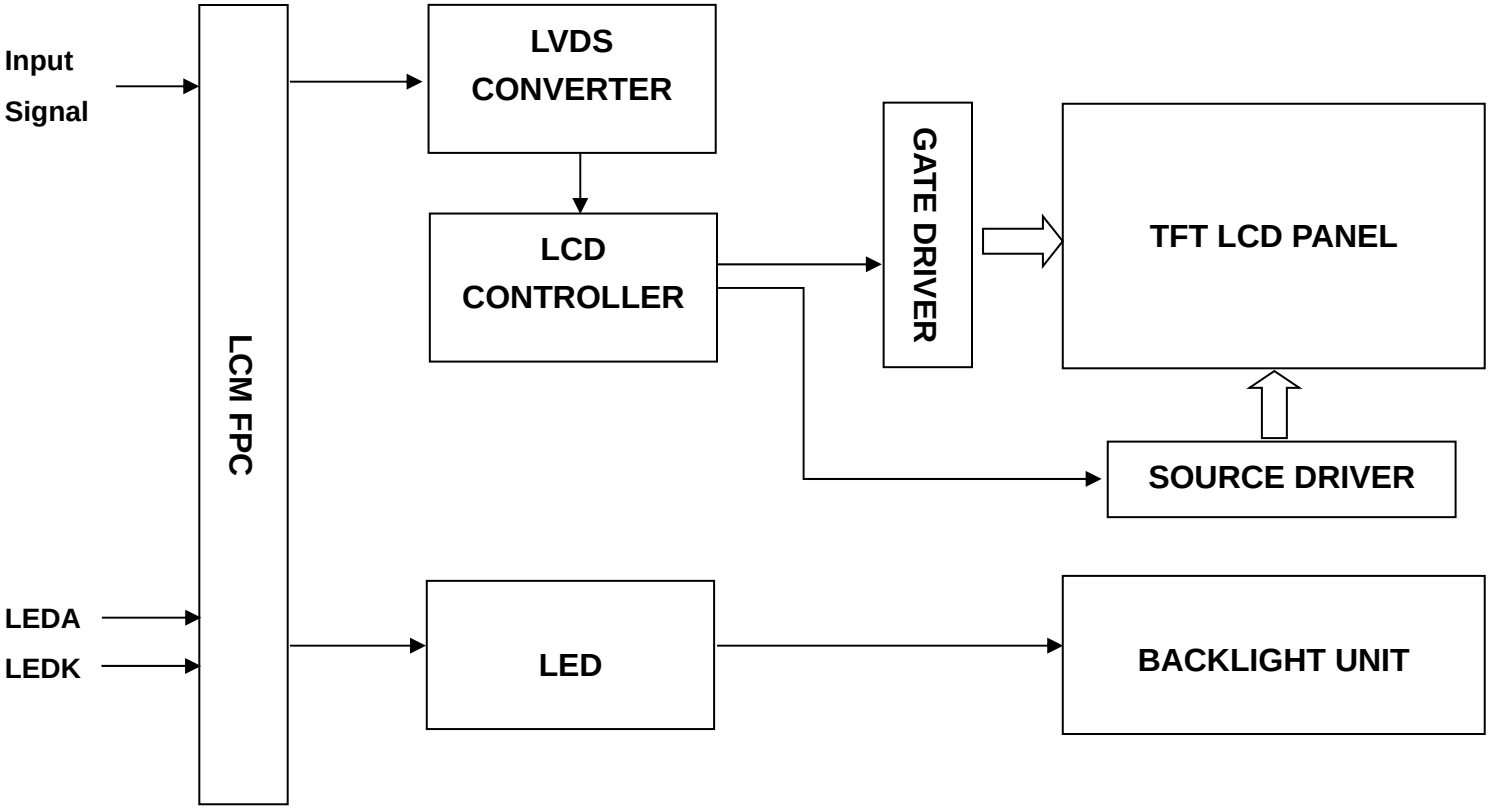
* Features

General Information Items	Specification	Unit	Note
	Main Panel		
Display area(AA)	95.04(H)*53.86(V) (4.3inch)	mm	
Driver element	TFT active matrix	-	
Display colors	16.7M	colors	
Number of pixels	800(RGB)*480	dots	
Pixel arrangement	RGB vertical stripe	-	
Pixel pitch	0.1188(H)*0.1122(V)	mm	
Viewing angle	Free	o'clock	
Controller IC	ST7262	-	
Display mode	Transmissive /Normally Black	-	
LCM Interface	8BIT LVDS	-	
Operating temperature	-30～+85	℃	
Storage temperature	-30～+85	℃	

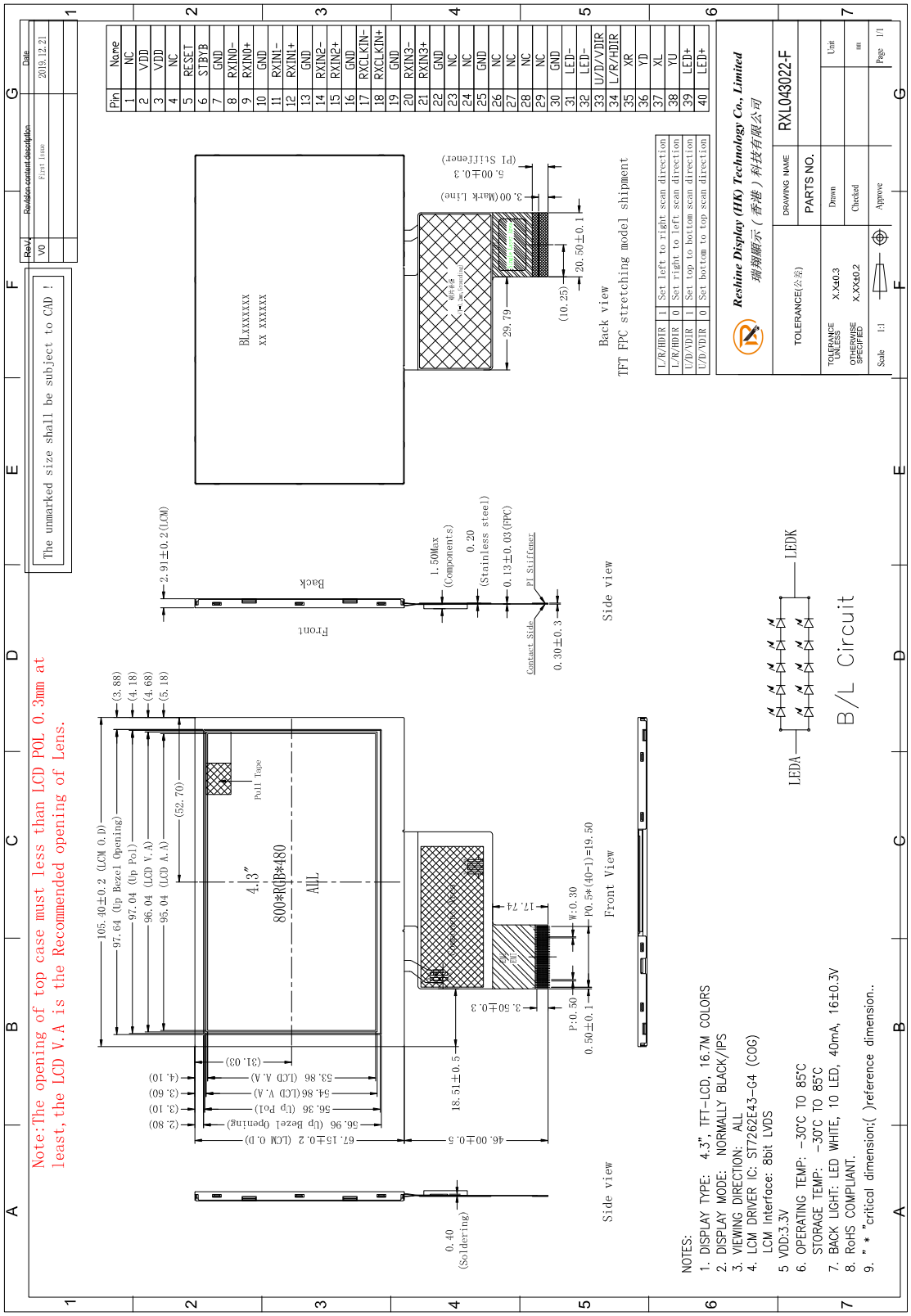
* Mechanical Information

Item		Min.	Typ.	Max.	Unit	Note
Module size	Horizontal(H)	-	105.40	-	mm	
	Vertical(V)	-	67.15	-	mm	
	Depth(D)	-	2.91	-	mm	
Weight		-	--	-	g	

1. Block Diagram



2. Outline dimension



Pin	None
1	NC
2	VDD
3	VDD
4	NC
5	RESET
6	STBYB
7	GND
8	RXIN0-
9	RXIN0+
10	GND
11	RXIN1-
12	RXIN1+
13	GND
14	RXIN2-
15	RXIN2+
16	GND
17	RXCLKIN-
18	RXCLKIN+
19	GND
20	RXIN3-
21	RXIN3+
22	GND
23	NC
24	NC
25	GND
26	NC
27	NC
28	NC
29	NC
30	GND
31	LED-
32	LED-
33	U/D/V/DIR
34	L/R/HDIR
35	XR
36	YD
37	XL
38	YU
39	LED+
40	LED+

L/R/HDIR	1	Set left to right scan direction
L/R/HDIR	0	Set right to left scan direction
U/D/VDIR	1	Set top to bottom scan direction
U/D/VDIR	0	Set bottom to top scan direction

Rev	Revision content description	Date
V0	First Issue	2019.12.21

3. Input terminal Pin Assignment

NO.	SYMBOL	DISCRIPTION	I/O
1	NC	--	--
2	VDD	Supply voltage(3.3V).	P
3	VDD	Supply voltage(3.3V).	P
4	NC	--	--
5	RESET	Reset pin. The chip is in reset state when RESETB=0.	I
6	STBYB	Display power control PIN. H: Power ON. L: Power OFF. Internal pull down resistor 100K.	I
7	GND	Ground.	P
8	RXIN0-	- LVDS differential data input	I
9	RXIN0+	+ LVDS differential data input	I
10	GND	Ground.	P
11	RXIN1-	- LVDS differential data input	I
12	RXIN1+	+ LVDS differential data input	I
13	GND	Ground.	P
14	RXIN2-	- LVDS differential data input	I
15	RXIN2+	+ LVDS differential data input	I
16	GND	Ground.	P
17	RXCLKIN-	- LVDS differential clock input	I
18	RXCLKIN+	+ LVDS differential clock input	I
19	GND	Ground.	P
20	RXIN3-	- LVDS differential data input	I
21	RXIN3+	+ LVDS differential data input	I
22	GND	Ground.	P
23	NC	--	--

24	NC	--	--
25	GND	Ground.	P
26	NC	--	--
27	NC	--	--
28	NC	--	--
29	NC	--	--
30	GND	Ground.	I
31	LED-	LED Cathode	P
32	LED-	LED Cathode	P
33	U/D/VDIR	Horizontal shift direction (source output) selection(NOTE1)	I
34	L/R/HDIR	Vertical shift direction (gate output) selection(NOTE1)	I
35	XR(NC)	Touch panel Right Glass Terminal	A/D
36	YD(NC)	Touch panel Bottom Film Terminal	A/D
37	XL(NC)	Touch panel LIFT Glass Terminal	A/D
38	YU(NC)	Touch panel Top Film Terminal	A/D
39	LED+	LED Anode	P
40	LED+	LED Anode	P

NOTE1

L/R	1	Set left to right scan direction
L/R	0	Set right to left scan direction.
U/D	1	Set top to bottom scan direction
U/D	0	Set bottom to top scan direction

4. LCD Optical Characteristics

4.1 Optical specification

Item		Symbol	Condition	Min.	Typ.	Max.	Unit.	Note
Contrast Ratio		CR	Θ=0 Normal viewing angle	--	1200	--		*(2)
Response time	Rising	$T_{R+}T_F$		--	30	--	msec	*(3)
	Falling			--				
Color Gamut		S(%)		--	50	--	%	*(4)
Color Filter Chromacicity	White	W_X		0.2641	0.3041	0.3441		CA-310 Test
		W_Y		0.2906	0.3306	0.3706		
	Red	R_X		0.5815	0.6015	0.6215		
		R_Y		0.3466	0.3666	0.3866		
	Green	G_X		0.3190	0.3390	0.3590		
		G_Y		0.5332	0.5532	0.5732		
	Blue	B_X		0.1305	0.1505	0.1705		
		B_Y		0.0969	0.1169	0.1369		
Viewing angle	Hor.	ΘL	CR>10	--	80	--		*(1)
		ΘR		--	80	--		
	Ver.	ΘU		--	80	--		
		ΘD		--	80	--		
Option View Direction		Free						

*The data comes from the LCD specification.

Measuring Condition

Measuring surrounding : dark room

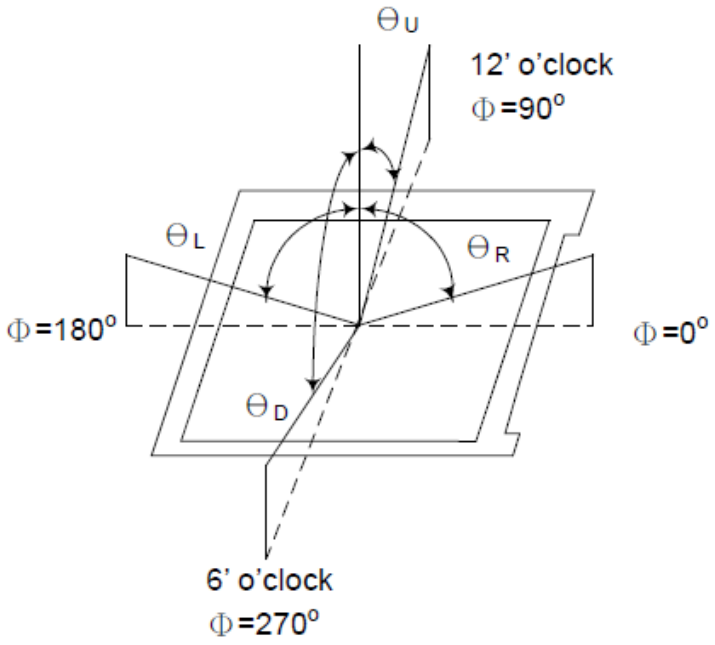
Ambient temperature : 25±2oC

15min. warm-up time.

Measuring Equipment

FPM520 of Westar Display technologies, INC., which utilized SR-3 for Chromaticity and BM-5A for other optical characteristics.

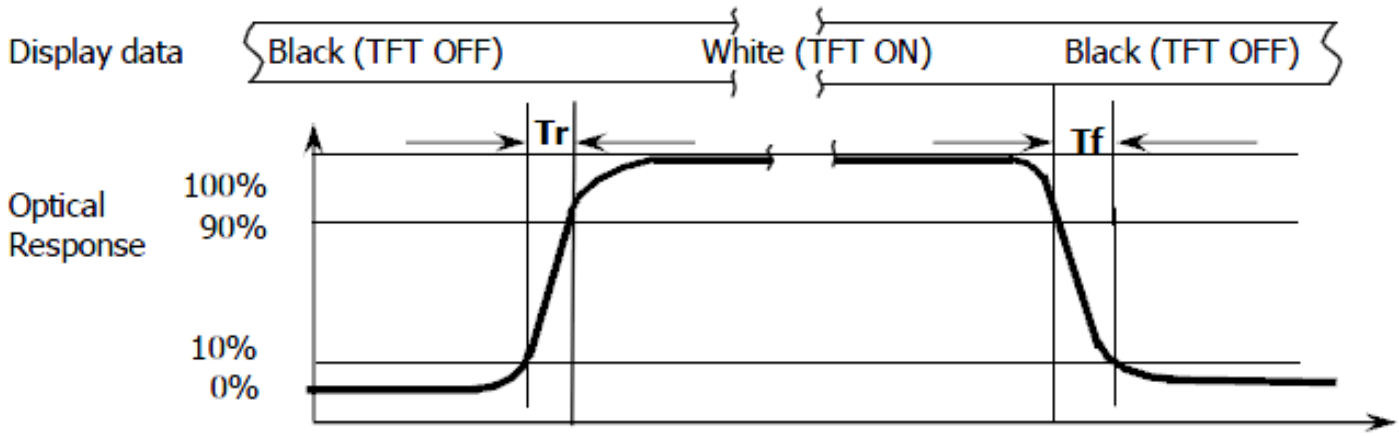
Note (1): Definition of Viewing Angle :



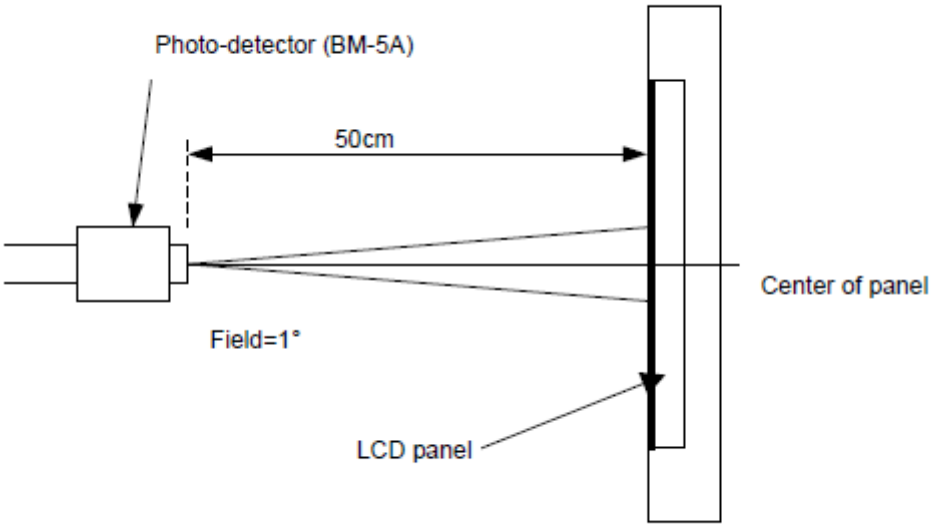
Note (2): Definition of Contrast Ratio(CR) :measured at the center point of panel

$$CR = \frac{\text{Luminance with all pixels white}}{\text{Luminance with all pixels black}}$$

Note (3): Response Time



Note (4): Definition of optical measurement setup



5. Electrical Characteristics

5.1 Absolute Maximum Rating

Characteristics	Symbol	Min.	Max.	Unit	Note
Digital Supply Voltage	VDD	-0.3	4.0	V	Note1
Operating temperature	T_{OP}	-30	+85	℃	
Storage temperature	T_{ST}	-30	+85	℃	

NOTE1: If the absolute maximum rating of even is one of the above parameters is exceeded even momentarily, the quality of the product may be degraded. Absolute maximum ratings, therefore, specify the values exceeding which the product may be physically damaged. Be sure to use the product within the range of the absolute maximum ratings.

5.2 DC Electrical Characteristics

Characteristics	Symbol	Min.	Typ.	Max.	Unit	Note
Digital Supply Voltage	VDD	3.0	3.3	3.6	V	
Normal mode Current consumption	IDD	--	40	--	mA	
Level input voltage	V_{IH}	0.7VDD		VDD	V	
	V_{IL}	GND		0.3 VDD	V	
Level output voltage	V_{OH}	VDD-0.4		VDD	V	
	V_{OL}	GND		GND+0.4	V	

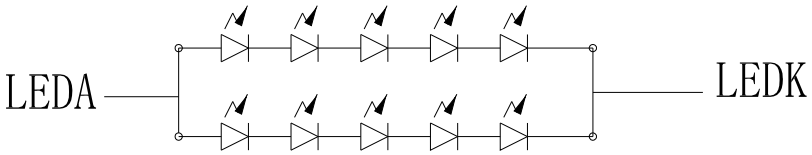
5.3 LED Backlight Characteristics

The back-light system is edge-lighting type with 10chips LED

Item	Symbol	Min.	Typ.	Max.	Unit	Note
Forward Current	I_F	30	40	--	mA	
Forward Voltage	V_F	--	16	--	V	
LCM Luminance	LV	550	600	--	cd/m2	Note3
LED life time	Hr	--	50000	--	Hour	Note1,2
Uniformity	Avg	80	--	--	%	Note3

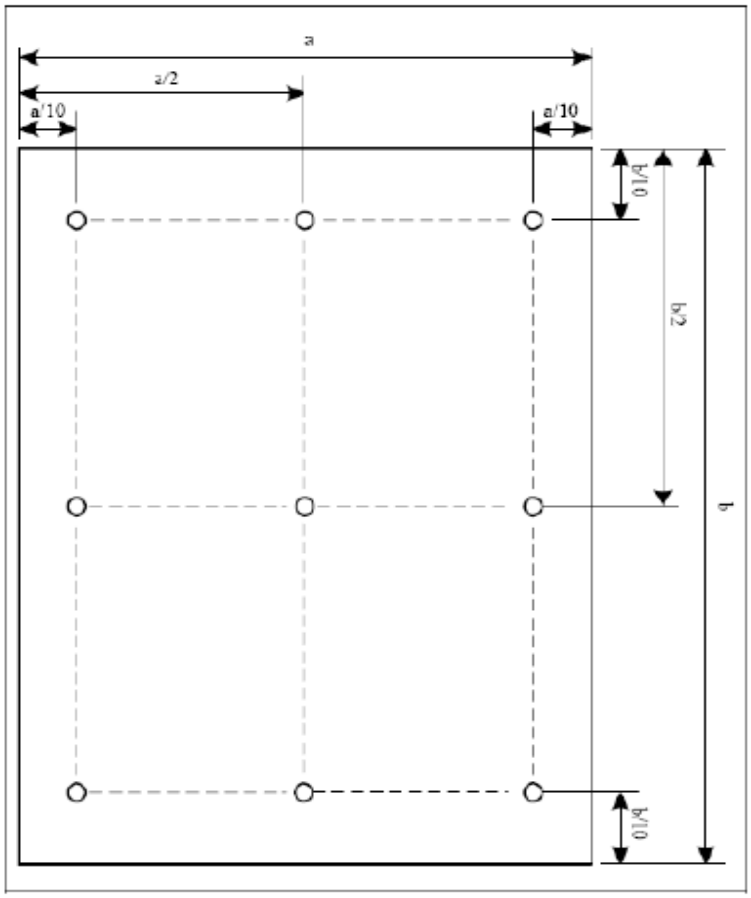
Note1: LED life time (Hr) can be defined as the time in which it continues to operate under the condition: Ta=25±3 ℃, typical IL value indicated in the above table until the brightness becomes less than 50%.

Note 2: The “LED life time” is defined as the module brightness decrease to 50% original brightness at Ta=25℃ and IL=40mA. The LED lifetime could be decreased if operating IL is larger than 40mA. The constant current driving method is suggested.



B/L Circuit

Note (3) Luminance Uniformity of these 9 points is defined as below:

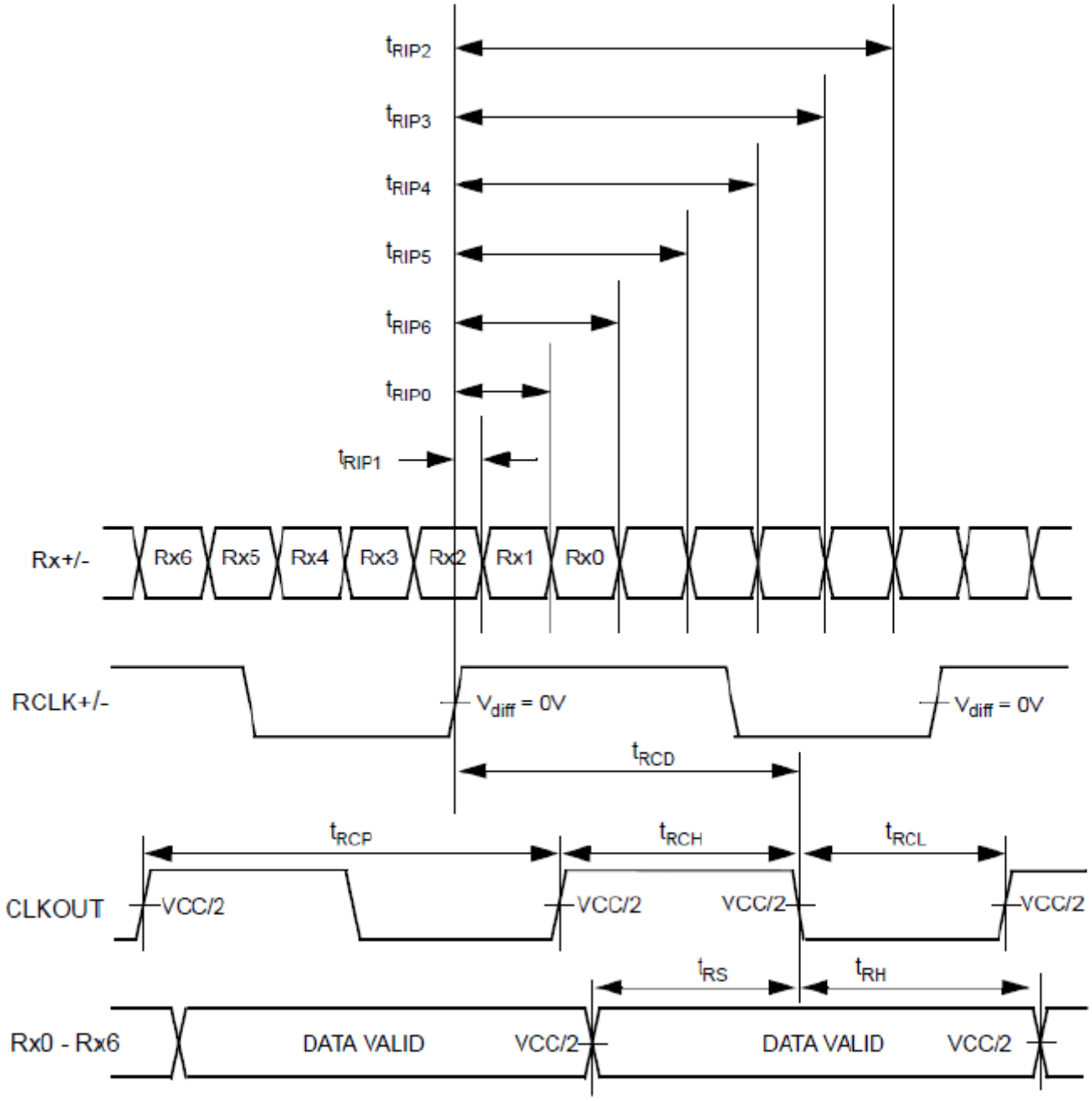


$$\text{Uniformity} = \frac{\text{minimum luminance in 9 points (1-9)}}{\text{maximum luminance in 9 points (1-9)}}$$

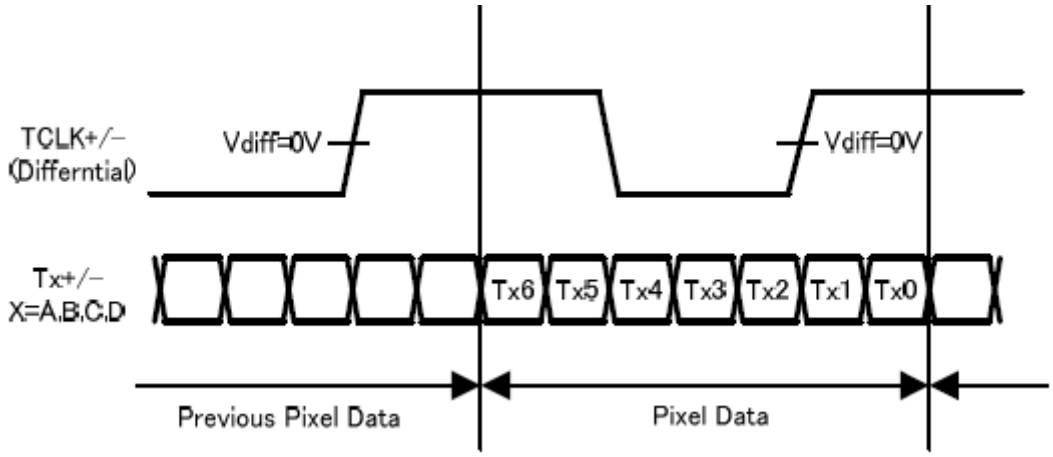
$$\text{Luminance} = \frac{\text{Total Luminance of 9 points}}{9}$$

6. AC Characteristics

6.1 LVDS Input Data Position



6.2 LVDS Data Timing Diagram



- **Horizontal timing**

Parameter	Symbol	Spec.			Unit
		Min.	Typ.	Max.	
Horizontal Display Area	thd		800		DCLK
DCLK frequency	fclk	-	30	50	MHz
One Horizontal Line	th	862	1056	1200	DCLK
HS pulse width	thpw	1	-	40	DCLK
HS Back Porch (Blanking)	thb		46		DCLK
HS Front Porch	thfp	16	210	354	DCLK
DE mode Blanking	th-thd	85	256	400	DCLK

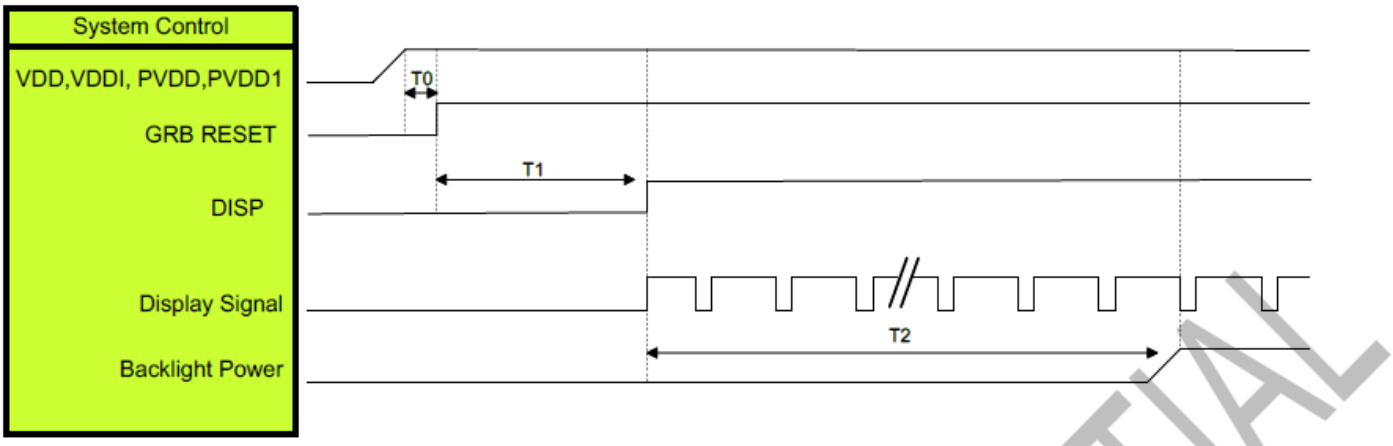
- **Vertical timing**

Parameter	Symbol	Spec.			Unit
		Min.	Typ.	Max.	
Vertical Display Area	tvd		480		T_H
VS period time	tv	513	525	650	T_H
VS pulse width	tvpw	3	-	20	T_H
VS Back Porch (Blanking)	tvb		23		T_H
VS Front Porch	tvfp	7	22	147	T_H
DE mode Blanking	tv-tvd	30	45	170	T_H

Confidential Copy

7. POWER ON/OFF SEQUENCE

7.1 Power On Sequence



Symbol	Description	Min. Time	Unit
T0	System power stability to GRB RESET signal	0	ms
T1	GRB RESET= “High” to DISP=”High”	10	ms
T2	Display Signal output to Backlight Power on	250	ms

Note: RGB interface Display signal: DCLK; VSYNC; HSYNC; DE; DR[7:0]; DG[7:0]; DB[7:0]

7.2 Power Off Sequence



Symbol	Description	Min. Time	Unit
T0	Backlight Power off to DISP=”Low”	5	ms
T1	DISP=”Low” to IC internal voltage discharge complete	100	ms

Note: RGB interface Display signal: DCLK; VSYNC; HSYNC; DE; DR[7:0]; DG[7:0]; DB[7:0]

SITRONIX CONFIDENTIAL

8. LCD Module Out-Going Quality Level

8.1 VISUAL & FUNCTION INSPECTION STANDARD

8.1.1 Inspection conditions

Inspection performed under the following conditions is recommended.

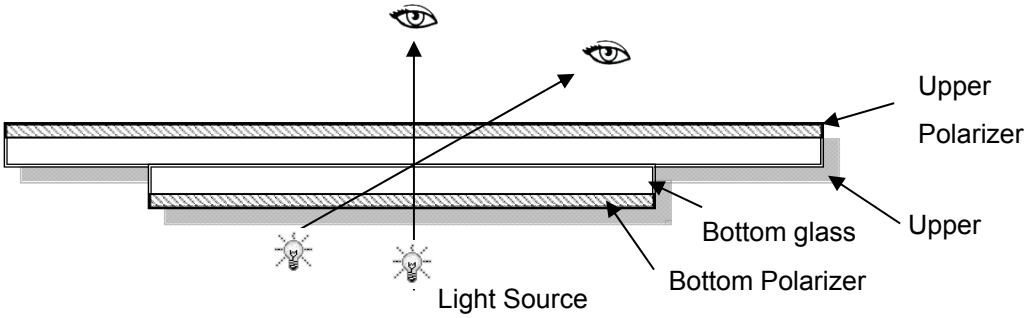
Temperature : 25±5℃

Humidity : 65%±10%RH

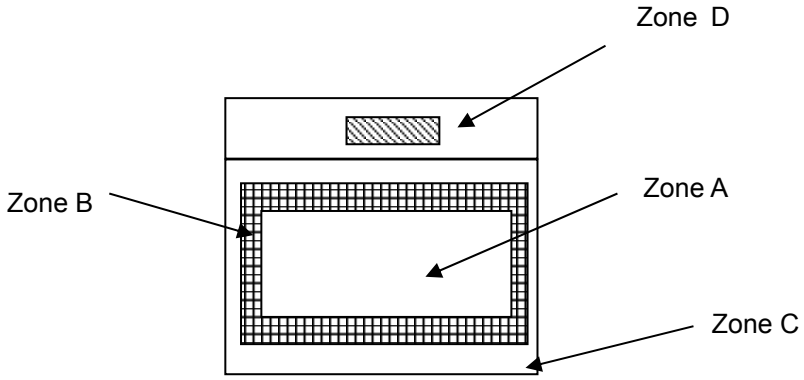
Viewing Angle : Normal viewing Angle.

Illumination: Single fluorescent lamp (300 to 700Lux)

Viewing distance:30-50cm



8.1.2 Definition



Zone A : Effective Viewing Area(Character or Digit can be seen)

Zone B : Viewing Area except Zone A

Zone C : Outside (Zone A+Zone B) which can not be seen after assembly by customer .)

Zone D : IC Bonding Area

Note:As a general rule ,visual defects in Zone C can be ignored when it doesn't effect product function or appearance after assembly by customer

8.1.3 Sampling Plan

According to GB/T 2828-2003 ; , normal inspection, Class Ⅱ

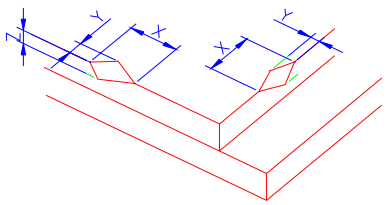
AQL:

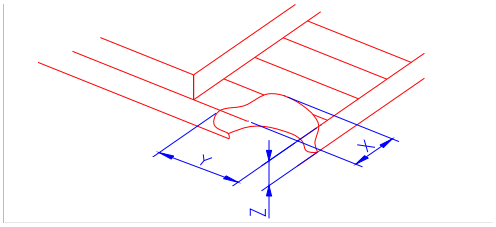
Major defect	Minor defect
0.65	1.5

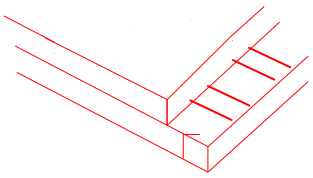
LCD: Liquid Crystal Display , TP: Touch Panel , LCM: Liquid Crystal Module

No	Items to be inspected	Criteria	Classification of defects
1	Functional defects	1) No display, Open or miss line 2) Display abnormally, Short 3) Backlight no lighting, abnormal lighting. 4) TP no function	Major
2	Missing	Missing component	
3	Outline dimension	Overall outline dimension beyond the drawing is not allowed	
4	Color tone	Color unevenness, refer to limited sample	Minor
5	Spot Line defect	Light dot, Dim spot,Polarizer Bubble ; Polarizer accidented spot.	
6	Soldering appearance	Good soldering , Peeling off is not allowed.	
7	LCD/Polarizer/TP	Black/White spot/line, scratch, crack, etc.	

8.1.4 Criteria (Visual)

<table>
<tr><th>Number</th><th>Items</th><th>Criteria(mm)</th></tr>
<tr><td rowspan="3">1.0 LCD Crack/Broken
NOTE:
X: Length
Y: Width
Z: Height
L: Length of ITO,
T: Height of LCD</td><td>(1) The edge of LCD broken</td><td>

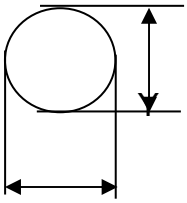
<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≤3.0mm</td><td><Inner border line of the seal</td><td>≤T</td></tr>
</table></td></tr>
<tr><td>(2)LCD corner broken</td><td>

<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≤3.0mm</td><td>≤L</td><td>≤T</td></tr>
</table></td></tr>
<tr><td>(3) LCD crack</td><td>

Crack
Not allowed</td></tr>
</table>

2.0

Spot defect



X

Φ=(X+Y)/2

① light dot（LCD/TP/Polarizer black/white spot , light dot, pinhole, dent, stain）

Zone / Size (mm)	Acceptable Qty		
	A	B	C
Φ≤0.10	Ignore		Ignore
0.10<Φ≤0.25	4(distance≧10mm)		
0.25<Φ≤0.35	3		
Φ>0.4	0		

②Dim spot（LCD/TP/Polarizer dim dot, light leakage、dark spot）

Zone / Size (mm)	Acceptable Qty		
	A	B	C
Φ≤0.1	Ignore		Ignore
0.10<Φ≤0.25	4(distance≧10mm)		
0.25<Φ≤0.35	3		
Φ>0.4	0		

③ Polarizer accidented spot

Zone / Size (mm)	Acceptable Qty		
	A	B	C
Φ≤0.2	Ignore		Ignore
0.3<Φ≤0.5	3(distance≧10mm)		
Φ>0.5	0		

④Pixel bad points（light dot，Dim dot，color dot）

Zone / Size (mm)	Acceptable Qty		
	A	B	C
Φ≤0.15	Ignore		Ignore
0.2<Φ≤0.3	2(distance≧10mm)		
Φ>0.4	0		

⑤ Polarizer Bubble

Zone / Size (mm)	Acceptable Qty		
	A	B	C
Φ≤0.2	Ignore		Ignore
0.3<Φ≤0.4	4(distance≧10mm)		
0.4<Φ≤0.5	3		
Φ>0.5	0		

<table>
<tr><td>3.0</td><td>Line defect (LCD/TP /Polarizer backlight black/white line, scratch, stain)</td><td>
<table>
<tr><td rowspan="2">Width(mm)</td><td rowspan="2">Length(mm)</td><td colspan="3">Acceptable Qty</td></tr>
<tr><td>A</td><td>B</td><td>C</td></tr>
<tr><td>Φ≤0.05</td><td>Ignore</td><td colspan="2">Ignore</td><td rowspan="3">Ignore</td></tr>
<tr><td>0.05<W≤0.06</td><td>L≤5.0</td><td colspan="2">N≤3</td></tr>
<tr><td>0.07<W≤0.08</td><td>L≤4.0</td><td colspan="2">N≤2</td></tr>
<tr><td>0.08<W</td><td colspan="4">Define as spot defect</td></tr>
</table>
</td></tr>
<tr><td>4.0</td><td>Electronic Components SMT</td><td>Not allow missing parts，solderless connection，cold solder joint，mismatch，The positive and negative polarity opposite</td></tr>
<tr><td>5.0</td><td>Display color& Brightness</td><td>1. Color：Measuring the color coordinates, The measurement standard according to the datasheet or samples.
2. Brightness：Measuring the brightness of White screen, The measurement standard according to the datasheet or Samples.</td></tr>
<tr><td>6.0</td><td>LCD Mura</td><td>By 5% ND filter invisible.</td></tr>
</table>

Criteria (functional items)

Number	Items	Criteria (mm)
1	No display	Not allowed
2	Missing segment	Not allowed
3	Short	Not allowed
4	Backlight no lighting	Not allowed
5	TP no function	Not allowed

9. Reliability Test Result

Item	Condition	Inspection after test
High Temperature Operating	85℃,96HR	Inspection after 2~4hours storage at room temperature, the sample shall be free from defects: 1.Air bubble in the LCD; 2.Non-display; 3.Missing segments/line; 4.Glass crack; 5.Current IDD is twice higher than initial value.
Low Temperature Operating	-30℃, 96HR	
High Temperature Storage	85℃, 96HR	
Low Temperature Storage	-30℃, 96HR	
High Temperature & High Humidity Operating	+60℃, 90% RH ,96 hours.	
Thermal Shock (Non-operation)	-30℃,30 min ↔ 85℃,30 min, Change time:5min 20CYC.	
ESD test	C=150pF, R=330,5points/panel Air:±8KV, 5times; Contact:±6KV, 5 times; (Environment: 15℃~35℃, 30%~60%).	
Vibration (Non-operation)	Frequency range:10~55Hz, Stroke:1.5mm Sweep:10Hz~55Hz~10Hz 2 hours for each direction of X.Y.Z. (6 hours for total) (Package condition).	
Box Drop Test	1 Corner 3 Edges 6 faces,80㎝(MEDIUM BOX)	

Remark:

1.The test samples should be applied to only one test item.

2.Sample size for each test item is 5~10pcs.

3.For Damp Proof Test, Pure water(Resistance＞10MΩ) should be used.

4.In case of malfunction defect caused by ESD damage, if it would be recovered to normal state after resetting, it would be judged as a good part.

5.Failure Judgment Criterion: Basic Specification, Electrical Characteristic, Mechanical Characteristic, Optical Characteristic.

10. Cautions and Handling Precautions

10.1 Handling and Operating the Module

(1) When the module is assembled, it should be attached to the system firmly.
Do not warp or twist the module during assembly work.
(2) Protect the module from physical shock or any force. In addition to damage, this may cause improper operation or damage to the module and back-light unit.
(3) Note that polarizer is very fragile and could be easily damaged. Do not press or scratch the surface.
(4) Do not allow drops of water or chemicals to remain on the display surface.
If you have the droplets for a long time, staining and discoloration may occur.
(5) If the surface of the polarizer is dirty, clean it using some absorbent cotton or soft cloth.
(6) The desirable cleaners are water, IPA (Isopropyl Alcohol) or Hexane.
Do not use ketene type materials (ex. Acetone), Ethyl alcohol, Toluene, Ethyl acid or Methyl chloride. It might permanent damage to the polarizer due to chemical reaction.
(7) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, legs, or clothes, it must be washed away thoroughly with soap.
(8) Protect the module from static; it may cause damage to the CMOS ICs.
(9) Use finger-stalls with soft gloves in order to keep display clean during the incoming inspection and assembly process.
(10) Do not disassemble the module.
(11) Protection film for polarizer on the module shall be slowly peeled off just before use so that the electrostatic charge can be minimized.
(12) Pins of I/F connector shall not be touched directly with bare hands.
(13) Do not connect, disconnect the module in the “Power ON” condition.

10.2 Storage and Transportation.

(1) Do not leave the panel in high temperature, and high humidity for a long time.
It is highly recommended to store the module with temperature from 0 to 35 ℃ and relative humidity of less than 70%
(2) Do not store the TFT-LCD module in direct sunlight.
(3) The module shall be stored in a dark place. When storing the modules for a long time, be sure to adopt effective measures for protecting the modules from strong ultraviolet radiation, sunlight, or fluorescent light.
(4) It is recommended that the modules should be stored under a condition where no condensation is allowed. Formation of dewdrops may cause an abnormal operation or a failure of the module.
In particular, the greatest possible care should be taken to prevent any module from being operated where condensation has occurred inside.

(5) This panel has its circuitry FPC on the bottom side and should be handled carefully in order not to be stressed.

11. Packing

TBD